

STRUCTURE Silicon Monolithic Integrated Circuit

PRODUCTS 3 channel video driver for DVD • STB

TYPE **B A 7 6 6 6 F S**

PACKAGE S S O P — A 1 6 (Plastic Mold)

#### Features

- 1) A low consumption electric power movement
- 2) Output Mute circuit built-in
- 3) The power save circuit built-in
- 4) Output protection circuit built -in
- 5) Output coupling capacitor is the small capacity by sag compensation circuit built-in
- 6) The driver can have two load (each channel)
- 7) Sync-tip-clamp input

#### ■ Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
Power Supply Voltage 1	Vcc	8	V
Power Dissipation	Pd	6 5 0	mW
Input voltage range	V <sub>IN</sub>	0 ~ VCC	V
Operating Temperature Range	Topr	− 2 5 ~ + 7 5	°C
Storage Temperature Range	Tstg	− 5 5 ~ + 1 2 5	°C

※ When absolute

temperature exceeds Ta=25°C, the rated value is reduced by 6.5mW/°C.

#### ■ Operating Voltage Range

Parameter	Symbol	Min.	TYP.	Max.	Unit
Operation Power Supply Voltage	Vcc	4 . 5	5 . 0	5 . 5	V

※ This product is not designed for protection against radioactive rays.

#### Status of this document

The Japanese version of this document is the formal specification.

A customer may use this translation version only for a reference to help reading the formal version.

If there are any differences in translation version of this document, formal version takes priority.

#### Application example

- ROHM cannot provide adequate confirmation of patents.
- The product described in this specification is designed to be used with ordinary electronic equipment or devices (such as audio-visua l equipment, office-automation equipment, communications devices, electrical appliances, and electronic toys). Should you intend to use this product with equipment or devices which require an extremely high level or reliability and the malfunction of which would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), please be sure to consult with our sales representative in advance.
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Parameter	Symbol	Limit			Unit	Condition
		MIN.	TYP.	MAX.		
Circuit current	ICC	11.7	23.4	35.1	mA	No signal
Maximum output level	Vom	2.6	3.0	—	Vp-p	f=1kHz,THD=1%
Voltage Gain	GV	5.5	6.0	6.5	dB	f=4.43MHz, 1Vp-p
Frequency characteristic	Gf	-1.0	0.0	1.0	dB	f=10MHz/1MHz,1Vp-p
MUTE Change level “H”	VTHH	2.5	—	VCC	V	
MUTE Change level “L”	VTHL	0	—	1.0	V	
MUTE Circuit current	IMT	—	2.0	4.0	mA	

Max6.95 (include BURR)

6.2±0.3

4.4±0.2

16 15 14 13 12 11 10 9

1 2 3 4 5 6 7 8

A7666FS

LOT NO.

0.3MIN

0.15±0.1

1.5±0.1

0.11

0.8

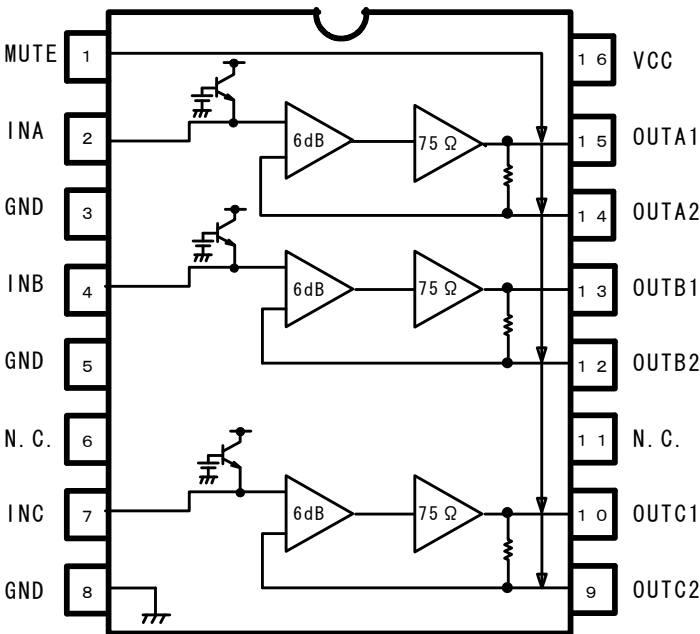
0.1

0.36±0.1

(UNIT : mm)

REV. C

■ BLOCK DIAGRAM



■ Pin number and pin name

PIN NO.	PIN NAME
1	MUTE
2	INA
3	GND
4	INB
5	GND
6	N.C.
7	INC
8	GND
9	OUTC2
10	OUTC1
11	N.C.
12	OUTB2
13	OUTB1
14	OUTA2
15	OUTA1
16	VCC1

**■ Cautions on use**

- (1) Numbers and data in entries are representative design values and are not guaranteed value of the items.
- (2) Absolute maximum ratings
  - If applied voltage, operating temperature range, or other absolute maximum ratings are exceeded, the LSI may be damaged. Do not apply voltages or temperatures that exceed the absolute maximum ratings. If you think of case in which absolute maximum ratings are exceeded, enforce fuses or other physical safety measures and investigate how not to apply the conditions under which absolute maximum ratings are exceeded to the LSI.
- (3) GND potential
  - Make the GND pin voltage such that it is the lowest voltage even when operating below it. Actually confirm that the voltage of each pin does not become a lower voltage than the GND pin, including transient phenomena.
- (4) Thermal design
  - Perform thermal design in which there are adequate margins by taking into account the allowable power dissipation in actual states of use.
- (5) Shorts between pins and misinstallation
  - When mounting the LSI on a board, pay adequate attention to orientation and placement discrepancies of the LSI. If it is misinstalled and the power is turned on, the LSI may be damaged. It also may be damaged if it is shorted by a foreign substance coming between pins of the LSI or between a pin and a power supply or a pin and a GND.
- (6) Operation in strong magnetic fields
  - Adequately evaluate use in a strong magnetic field, since there is a possibility of malfunction.

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